

N-Ch MOSFET

General Description

TheWSD4046DNDN56 is the highest performance trench N-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSD4046DN meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline

Absolute Maximum Ratings

- 100% EAS Guaranteed
- Green Device Available

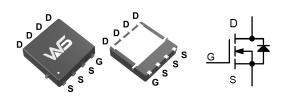
Product Summery

BVDSS	RDSON	ID
40V	8.0mΩ	45A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter
- DC-DC Power System
- Power Tool Application

DFN3x3-8L Pin Configuration



Units **Symbol Parameter** Rating 40 V Drain-Source Voltage V_{DS} V ± 20 V_{GS} Gate-Source Voltage Continuous Drain Current, VGS @ 10V 45 А I_D@T_C=25℃ 28 I_D@T_C=100℃ Continuous Drain Current, VGS @ 10V А Pulsed Drain Current^a 60 А I_{DM} EAS Single Pulse Avalanche Energy^b 25 mJ Avalanche Current 10 А I_{AS} 26 W **Total Power Dissipation** P_D@T_c=25℃ -55 to 150 °C $\mathsf{T}_{\mathsf{STG}}$ Storage Temperature Range -55 to 150 °C ТJ **Operating Junction Temperature Range**

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-Ambient ¹		62	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		4.7	°C/W

Note a : Package is limited to 60A.

Note b : UIS tested and pulse width limited by maximum junction temperature 150°C (initial temperature Tj=25°C).



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Electrical Characteristics (T_J=25⁻¹C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	40			V
$\triangle BV_{DSS} / \triangle T_J$	BV _{DSS} Temperature Coefficient	Reference to 25 $^\circ\!\!{\rm C}$, $I_D {=} 1 mA$		0.043		V/℃
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =10A		8	11	mΩ
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =5A		10	14	mΩ
V _{GS(th)}	Gate Threshold Voltage		1.2	1.6	2.5	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient			-6.94		mV/℃
I _{DSS}	Drain Source Leakage Current	V_{DS} =32V , V_{GS} =0V , TJ=25 $^\circ \! \mathbb{C}$			2	uA
	Drain-Source Leakage Current	V _{DS} =32V , V _{GS} =0V , TJ=55℃			10	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm20V$, V_{DS} = $0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =10A		22		S
R _g	Gate Resistance	V_{DS} =0V , V_{GS} =0V , f=1MHz		1.7		Ω
Qg	Total Gate Charge (10V)	V _{DS} =20V , V _{GS} =10V , I _D =10A		38		nC
Q _{gs}	Gate-Source Charge			7		
Q _{gd}	Gate-Drain Charge			8		
T _{d(on)}	Turn-On Delay Time			12		
Tr	Rise Time	V _{DD} =20V , V _{GEN} =10V ,		12		ns
T _{d(off)}	Turn-Off Delay Time	R _G =1Ω, I _D =1A ,RL=15Ω.		39		
T _f	Fall Time			10		
C _{iss}	Input Capacitance	V _{DS} =20V , V _{GS} =0V , f=1MHz		2450		
C _{oss}	Output Capacitance			185		pF
C _{rss}	Reverse Transfer Capacitance			170		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}	$-V_G=V_D=0V$, Force Current			20	А
I _{SM}	Pulsed Source Current ^{2,6}				56	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =10A , TJ=25℃			1.3	V

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec . 2. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2% 3. The EAS data shows Max. rating . The test condition is V_{DD}=20V,V_{GS}=10V,L=0.5mH,I_{AS}=10A 4. The power dissipation is limited by 150°C junction temperature

5. The Min. value is 100% EAS tested guarantee.

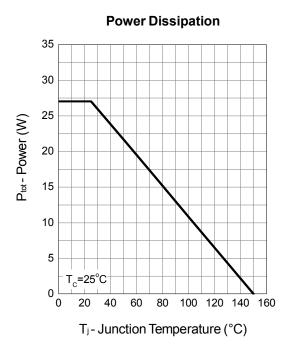
6. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

7.Package limitation current is 60A.

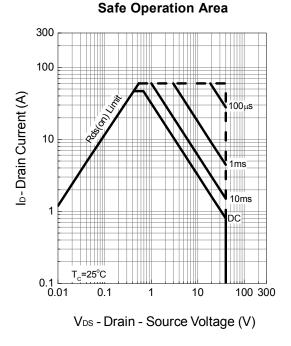


N-Ch MOSFET

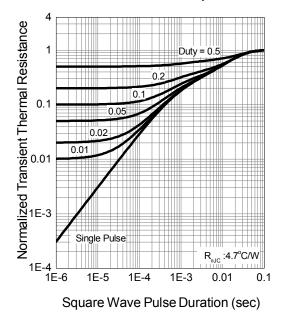
Typical Characteristics



T_j-Junction Temperature (°C)



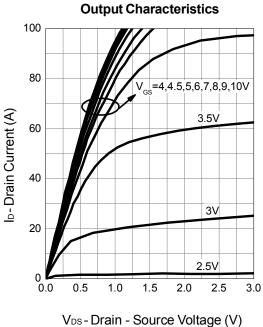
Thermal Transient Impedance

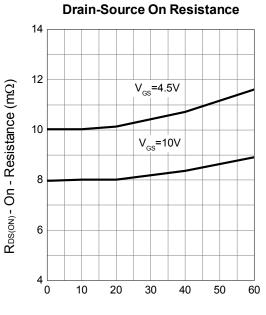




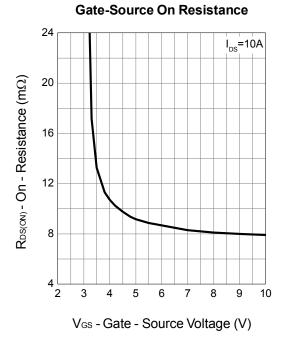
N-Ch MOSFET

Typical Characteristics

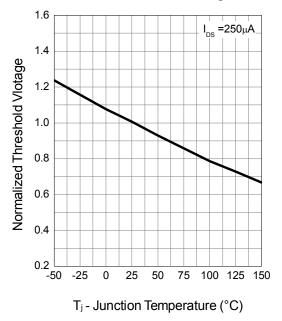




ID-Drain Current (A)



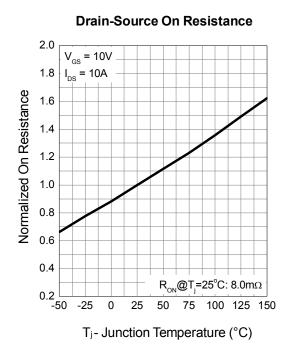
Gate Threshold Voltage





N-Ch MOSFET

Typical Characteristics



Capacitance 4000 Frequency=1MHz 3500 3000 2600 Ciss 2000 2000 1200 750 600 - 250 - 250 300 Coss

16

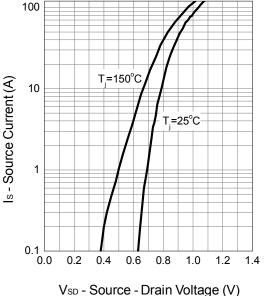
24

VDS - Drain - Source Voltage (V)

32

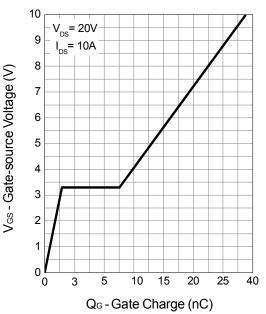
40

100



Source-Drain Diode Forward





150

0

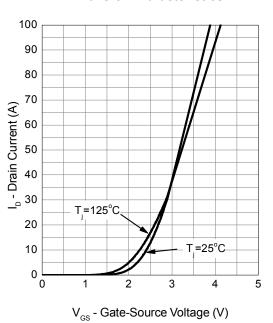
0

Crss

8



Typical Characteristics



Transfer Characteristics



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